

Title (en)
THERMOPLASTIC RESIN COMPOSITION AND MOLDED PRODUCT COMPRISING SAME

Title (de)
THERMOPLASTISCHE HARZZUSAMMENSETZUNG UND FORMPRODUKT DAMIT

Title (fr)
COMPOSITION DE RÉSINE THERMOPLASTIQUE ET PRODUIT MOULÉ LA COMPRENANT

Publication
EP 3357965 A4 20190626 (EN)

Application
EP 16852050 A 20160929

Priority
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• KR 2016010872 W 20160929

Abstract (en)
[origin: EP3357965A1] A thermoplastic resin composition of the present invention contains: a first aromatic vinyl-based resin, which is a copolymer of an aromatic vinyl-based monomer and a maleic acid anhydride; a second aromatic vinyl-based resin, which is a copolymer of an aromatic vinyl-based monomer, a maleic acid anhydride, and a maleimide-based monomer represented by chemical formula 1; a rubber-modified vinyl-based graft copolymer; and a reinforcing filler. The thermoplastic resin composition is excellent in view of heat resistance, rigidity, dimensional stability, and the like.

IPC 8 full level
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AL AT BE BG CH CY CZ DE DK EE ES FI FR GB GR HR HU IE IS IT LI LT LU LV MC MK MT NL NO PL PT RO RS SE SI SK SM TR

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